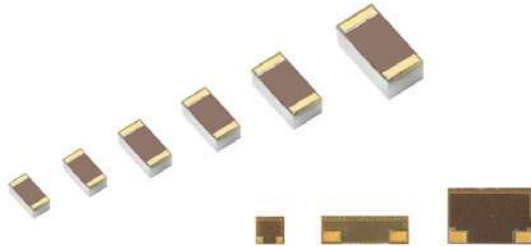


**Ultra High Precision Z1 Foil Technology Gold Wire Bondable Chip Resistor for Hybrid Circuits for High Temperature Applications up to +240°C, Long Term Stability of 0.05%**



**INTRODUCTION**

Vishay Foil Resistors (VFR) introduces a new line of Ultra Precision Bulk Metal® Z1 Foil Technology: hybrid chip resistors, connected using gold wire bonding. The HTHG series features two different layouts of chip designs according to the sizes (see figure 3 and table 4). These new types of hybrid chips were especially designed for high temperature applications up to +240°C<sup>(1)</sup> (working power: to 150mW at +220°C), and include gold plated terminals.

The HTHG series is available in any value within the specified resistance range. VFR's application engineering department is available to advise and make recommendations.

For non-standard technical requirements and special applications, please contact [foil@vpgsensors.com](mailto:foil@vpgsensors.com).

**FEATURES**

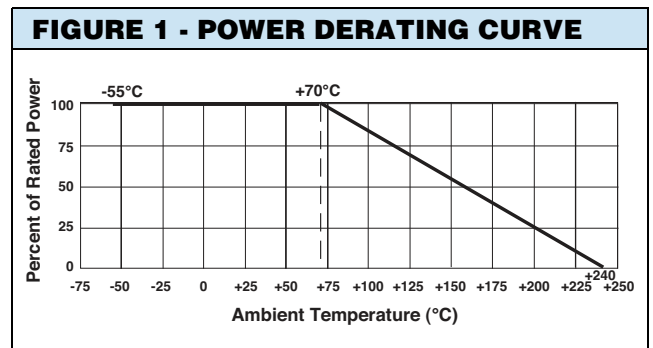
- Temperature coefficient of resistance (TCR): ±3 ppm/°C typical (-55 °C to +220 °C, +25 °C ref.)
- Resistance range: 5 Ω to 100 kΩ (for higher or lower values, please contact VFR's application engineering department)
- Resistance tolerance: to ± 0.02 %
- **Connection method: gold wire bonding**
- **Working power: to 150mW at +220°C**
- **Long term stability: to ± 0.05 % at +240°C for 2000h, no power**
- **Load life stability: to 0.05% at +220°C for 2000h at working power**
- Bulk Metal Foil resistors are not restricted to standard values; specific "as required" values can be supplied at no extra cost or delivery (e.g. 1K2345 vs. 1K)
- Thermal stabilization time < 1 s (nominal value achieved within 10 ppm of steady state value)
- Electrostatic discharge (ESD) at least to 25 kV
- Non inductive, non capacitive design
- Rise time: 1 ns effectively no ringing
- Current noise: 0.010 μV (RMS)/Volt of applied voltage (< -40 dB)
- Voltage coefficient: < 0.1 ppm/V
- Non inductive: < 0.08 μH
- Non hot spot design
- Terminal finish: gold plated (lead (Pb)-free alloy)
- Prototype quantities available, please contact [foil@vpgsensors.com](mailto:foil@vpgsensors.com)



<b>TABLE 1 - TOLERANCE AND TCR VS. RESISTANCE VALUE (1)(2)</b> (-55 °C to +220 °C, +25 °C Ref.)		
RESISTANCE VALUE (Ω)	TOLERANCE (%)	TCR Typical (ppm/°C)
100 to 100K	± 0.02	± 3
50 to < 100	± 0.05	
25 to < 50	± 0.1	
10 to < 25	± 0.25	
5 to 10	± 0.5	

**Notes**

- (1) Performances obtained with ceramic PCB.  
 (2) For tighter performances or non-standard values up to 150 kΩ, please contact VFR's application engineering department by sending an e-mail to the address in the footer below.



## HIGH TEMPERATURE PRODUCTS

Resistors are the passive building blocks of an electrical circuit. They may be used for dropping the voltage, buffering the surge when the circuit is turned on, providing feedback in a monitoring loop, sensing current flow, etc. When the application requires stability over time and load, initial accuracy, minimal change with temperature for more than 200 °C, resistance to moisture and a number of other characteristics that will be described, only the new generation of Bulk Metal<sup>®</sup> Foil resistors have the attributes needed for this application. Over the past few months, there has been considerable growth in the demand for precise, stable and reliable resistors that can operate in harsh environments and especially at high temperatures to 220 °C. Many analog circuits for industrial, military, aerospace, medical, down-hole, oil well and automotive applications require passive components such as resistors to have a minimal drift from their initial values when operating above + 175 °C and in humid environments. In these applications, the most important factor is the end of life tolerance (which is part of the stability) and to a lesser extent, the initial tolerance.

The Bulk Metal Foil resistors provide stabilities well under the maximum allowable drift required by customers' specifications through thousands of hours of operation under harsh conditions, such as the extreme temperatures and radiation-rich environments of down-hole oil-well logging applications in the frigid arctic, under the sea or in deep space. All Bulk Metal Foil resistors receive stabilization processing, such as repetitive short term power overloads, to assure reliable service through the unpredictable stresses of extreme operation. Compared to Bulk Metal Foil, thick and thin film resistor elements are produced with a non-controllable material. Heat or mechanical stresses on the resistive elements cause the particles forming the film to expand. However, after these stresses are alleviated, the particles in the film matrix do not return to the exact original position. That degenerates their overall stability.

Ultra High Precision Bulk Metal Foil technology includes many types of resistors with a variety of standard configurations that can withstand unconventional environmental conditions above and below the earth's surface using special post manufacturing operations specially developed for this purpose. The stability of a resistor depends primarily on its history of exposures to high temperature. Stability is affected by:

1. Changes in the ambient temperature and heat from adjacent components (defined by the Temperature Coefficient of Resistance, or TCR)
2. Destabilizing thermal shock of suddenly-applied power (defined by the Power Coefficient of Resistance, or PCR)
3. Long-term exposure to applied power (load-life stability)
4. Repetitive stresses from being switched on and off

In very high-precision resistors that need to operate in an environment with temperatures above + 175 °C, these effects must be taken into account to achieve high stability with changes in load (Joule Effect) and ambient temperature.

The Bulk Metal Foil Resistors' new Z1 Foil technology provides an order of magnitude reduction in the Bulk Metal Foil element's sensitivity to temperature changes — both external and internal — with emphasis on long term stability in high temperature environments.

In order to take full advantage of the low TCR and long term stability improvement, it is necessary to take into account the differences in the resistor's response to each of the above-mentioned effects. As described below, new products have been developed to successfully deal with these factors. For high temperature applications where stability and total error budget is the main concern, the new generation of Bulk Metal Foil resistors offers the best resilience against time at elevated temperature.

The Bulk Metal Foil technology allows us to produce customer-oriented products designed to satisfy unique and specific technical requirements. In addition to the special chip stabilization under extreme environment conditions in the production line, we offer additional specially oriented post manufacturing operations (PMO) for high temperature applications that require an even higher degree of reliability and stability.

Electrostatic Discharge (ESD) is another potential problem that can cause unpredictable failure in high temperature applications that increase the sensitivity of the resistors to ESD.

ESD damage to electronic devices can occur at any point in the device's life cycle, from manufacturing to field service. A resistor that is exposed to an ESD event may fail immediately or may experience a latent defect. With latent defects, premature failure can occur after the resistor is already functioning in the finished product after an unpredictable length of service. Bulk Metal Foil resistors are capable of withstanding electrostatic discharges at least to 25 kV volts without degradation.

VFR's Application Engineering department is always available to assist with any special requirements you might have. If you are not sure which resistor best suits your needs, please do not hesitate to contact them for more information: [foil@vpgsensors.com](mailto:foil@vpgsensors.com)

**TABLE 2 - PRODUCT SPECIFICATIONS**

PRODUCT	CONNECTING METHOD	SIZES
HTHG	Gold wire bonding	5x5,15x5,15x10
		0603,0805,1206,1506,2010,2512

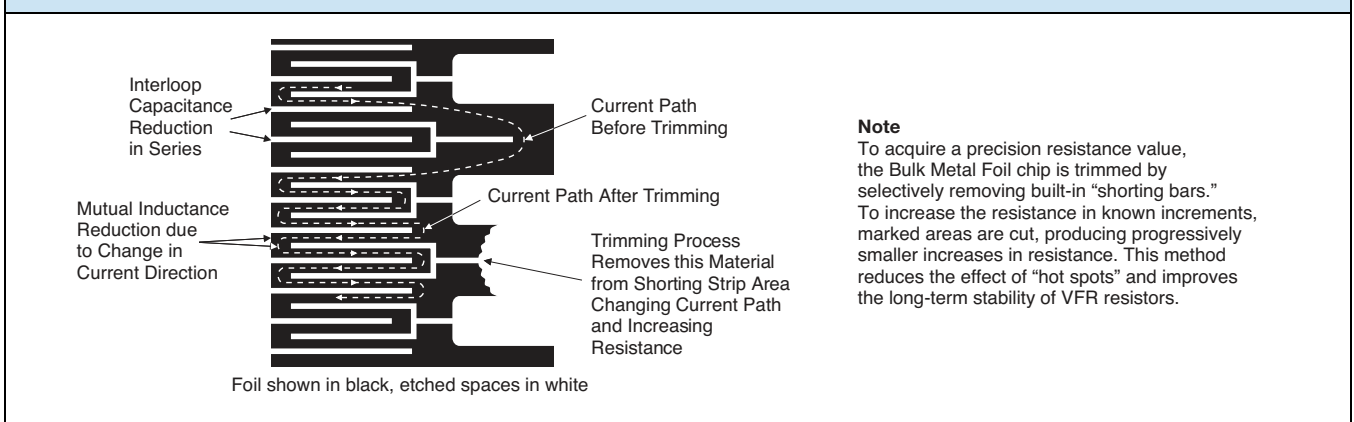
**TABLE 3 - SPECIFICATIONS**

CHIP SIZE	WORKING POWER (mW) at + 220 °C <sup>(1)</sup>	RESISTANCE RANGE (Ω)
5x5	20	5 to 10K
15x5	50	5 to 30K
15x10	75	30K to 80K
0603	12.5	100 to 5K
0805	20	5 to 8K
1206	33	5 to 25K
1506	40	5 to 30K
2010	100	5 to 70K
2512	150	5 to 100K

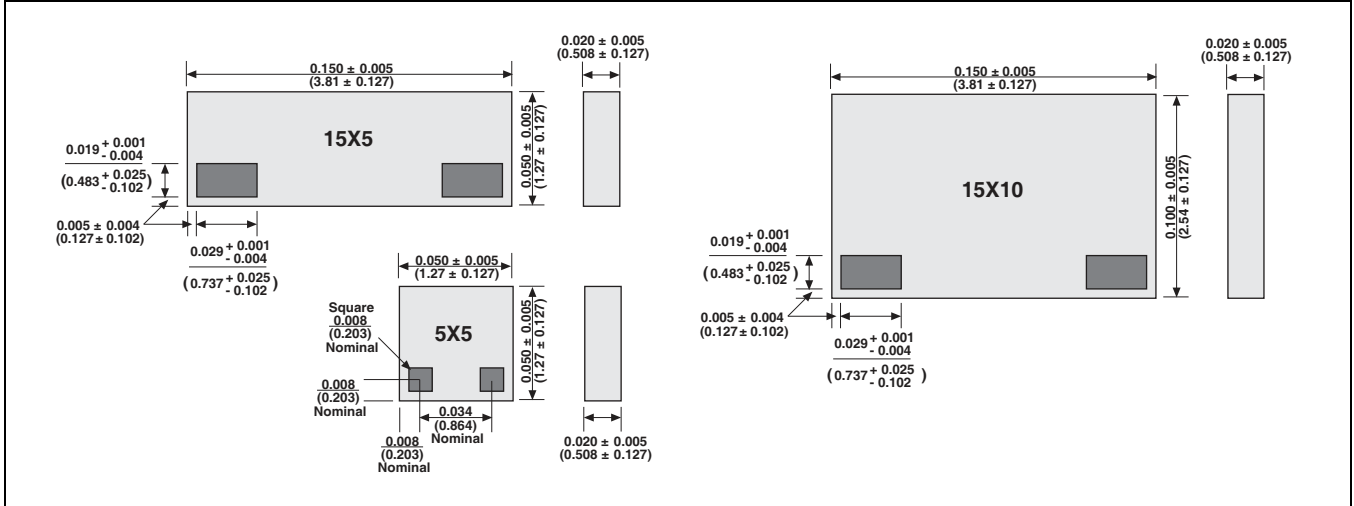
**Note**

<sup>(1)</sup> Maximum working voltage at +220°C for a given resistance value is calculated using  $V = \sqrt{P \times R}$ .

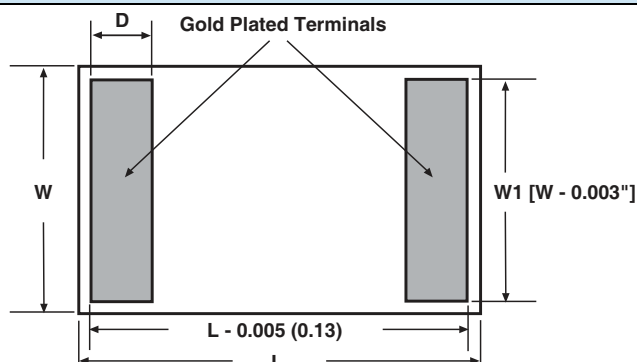
**FIGURE 2 - TRIMMING TO VALUES** (Conceptual Illustration)



**FIGURE 3 - DIMENSIONS** in inches (millimeters)



**TABLE 4 - DIMENSIONS** in inches (millimeters)\*



CHIP SIZE	L ± 0.005 (0.13)	W ± 0.005 (0.13)	THICKNESS ± 0.003 (0.08)	D NOMINAL
0603	0.063 (1.60)	0.032 (0.81)	0.02 (0.50)	0.006 (0.15)
0805	0.079 (2.01)	0.049 (1.24)	0.02 (0.50)	0.010 (0.25)
1206	0.126 (3.20)	0.062 (1.57)	0.02 (0.50)	0.015 (0.38)
1506	0.150 (3.81)	0.062 (1.57)	0.02 (0.50)	0.012 (0.30)
2010	0.200 (5.08)	0.100 (2.54)	0.02 (0.50)	0.020 (0.51)
2512	0.250 (6.35)	0.126 (3.20)	0.02 (0.50)	0.024 (0.61)

**\* Notes**

- Vacuum pick up is recommended for handling

**TABLE 5 - PERFORMANCE LIMITS<sup>(1)(2)</sup>**

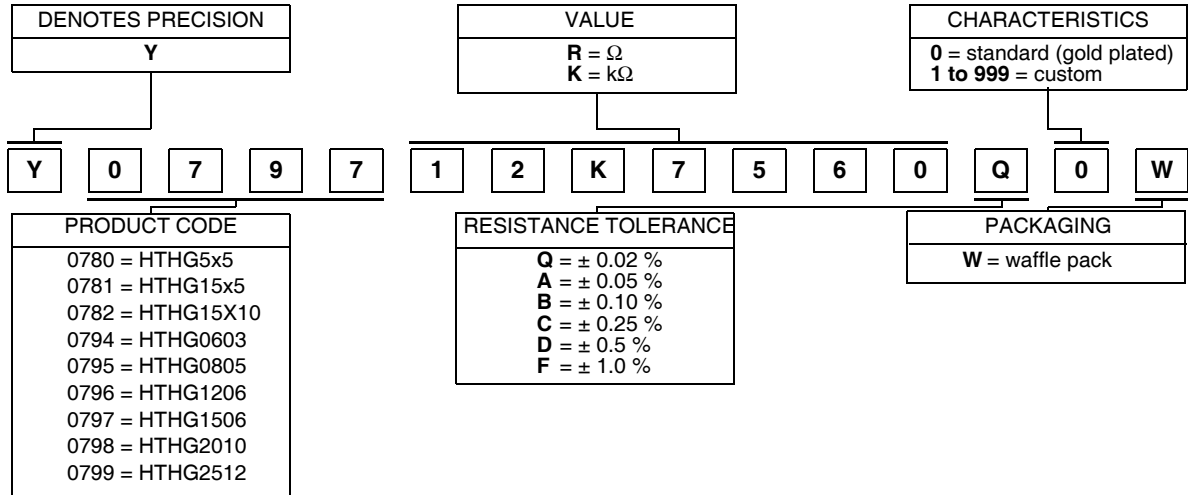
TEST	CONDITIONS	TYPICAL LIMIT % (PPM)	MAX LIMIT % (PPM)
Short Time Overload	6.25 x P <sub>nom.</sub>	± 0.001% (10)	±0.015% (150)
High Temperature Exposure	+240°C, 2,000 h	± 0.1% (1000)	±0.25% (2500)
Moisture Resistance	Per MIL-PRF-55342 (p. 4.8.9)	± 0.01% (100)	±0.05% (500)
Load Life Test, 220°C, 2,000 h	at working power (see Table 3)	± 0.05% (500)	±0.15% (1500)
Load Life Test, 70°C, 2,000 h	0603 – 100 mW, 0805 – 175 mW, 1206 – 270 mW, 1506 – 340 mW, 2010 – 850 mW, 2512 – 1.2 W	±0.005% (50)	±0.025% (250)
Thermal Shock	5 x (-65°C to +220°C)	±0.005% (50)	±0.02 (200)

<sup>(1)</sup> As shown + 0.01 Ω to allow for measurement errors at low values.

<sup>(2)</sup> Performances obtained with ceramic PCB.

**TABLE 6 - GLOBAL PART NUMBER INFORMATION (1)**

NEW GLOBAL PART NUMBER: Y079712K7560Q0W (preferred part number format)



FOR EXAMPLE: ABOVE GLOBAL ORDER Y0797 12K7560 Q 0 W:

TYPE: HTHG1506  
VALUES: 12.7560 k $\Omega$   
ABSOLUTE TOLERANCE: 0.02 %  
TERMINATION: standard (gold-plated)  
PACKAGING: waffle pack

HISTORICAL PART NUMBER: HTHG1506 12K756 Q W (WILL CONTINUE TO BE)

<b>HTHG1506</b>	<b>12K756</b>	<b>Q</b>	<b>W</b>
MODEL 0780 = HTHG5x5 0781 = HTHG15x5 0782 = HTHG15X10 0794 = HTHG0603 0795 = HTHG0805 0796 = HTHG1206 0797 = HTHG1506 0798 = HTHG2010 0799 = HTHG2512	RESISTANCE VALUE 12.756 k $\Omega$	TOLERANCE Q = $\pm 0.02\%$ A = $\pm 0.05\%$ B = $\pm 0.10\%$ C = $\pm 0.25\%$ D = $\pm 0.5\%$ F = $\pm 1.0\%$	PACKAGING W = waffle pack

**Note**

(1) For non-standard requests, please contact application engineering.

## EFFECTS OF GOLD WIRE

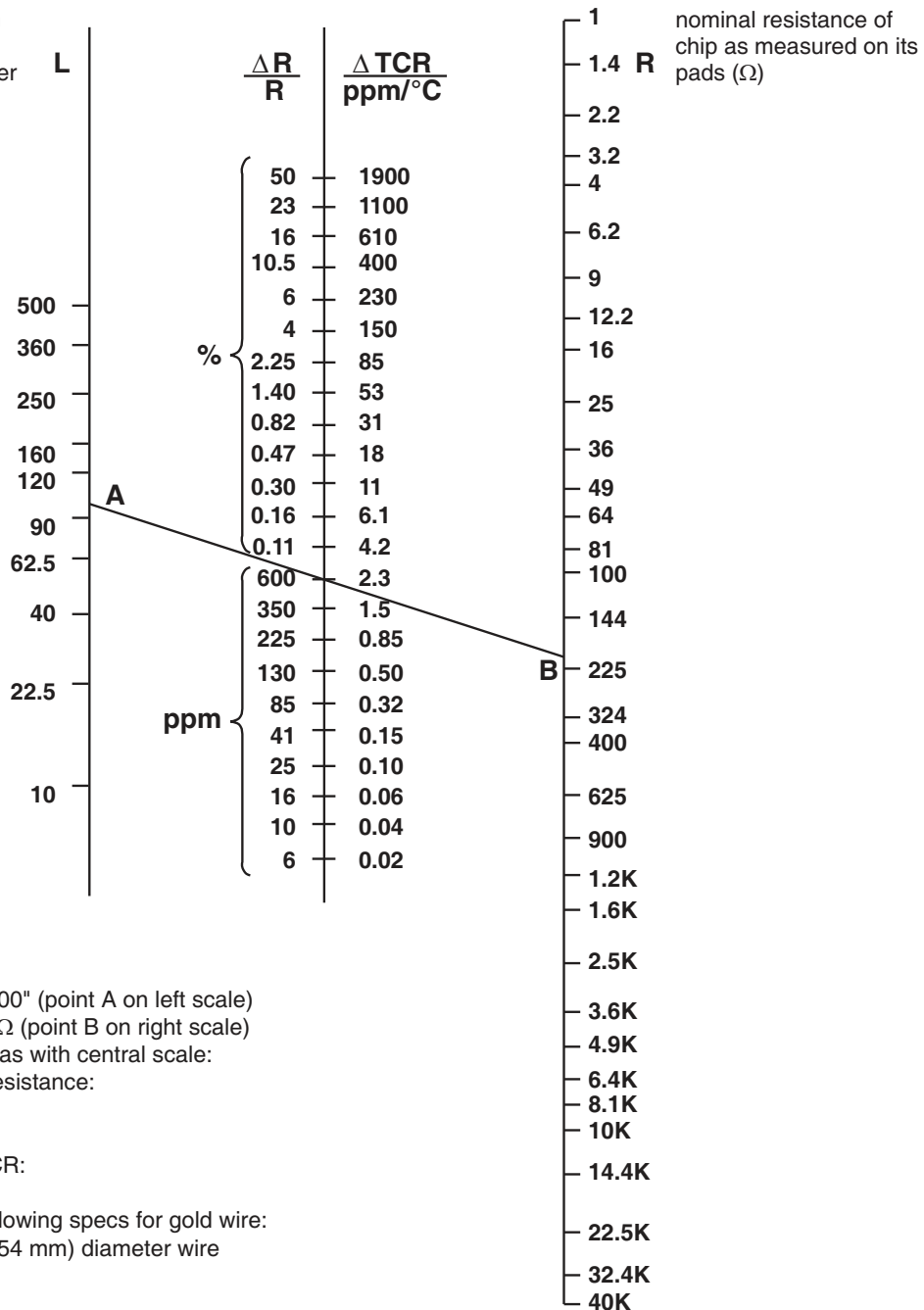
The bonding of the gold wires to the chip has an effect on the overall resistance and on the temperature coefficient, according to the length of wire used.

The nomogram below shows the effect on both parameters with varying lengths of 0.001" (0.0254 mm) diameter gold wire.

## NOMOGRAM

Change of resistance and TCR due to a length L of gold wire added at wire bonding.

thousandths of an inch  
total length of 2 gold  
wires of 0.001" diameter



### EXAMPLE:

Total length of wires L = 0.100" (point A on left scale)

Resistance of chip R = 200 Ω (point B on right scale)

Read on intersection of line as with central scale:

On left side - change of resistance:

$$\frac{\Delta R}{R} = 600 \text{ ppm}$$

On right side - change of TCR:

$$\Delta TCR = + 2.3 \text{ ppm}/^{\circ}C$$

Nomogram based on the following specs for gold wire:

- 1.2 Ω/inch for 0.001" (0.0254 mm) diameter wire
- TCR 3900 ppm/°C



## Disclaimer

ALL PRODUCTS, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE.

Vishay Precision Group, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "VPG"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

The product specifications do not expand or otherwise modify VPG's terms and conditions of purchase, including but not limited to, the warranty expressed therein.

VPG makes no warranty, representation or guarantee other than as set forth in the terms and conditions of purchase. **To the maximum extent permitted by applicable law, VPG disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.**

Information provided in datasheets and/or specifications may vary from actual results in different applications and performance may vary over time. Statements regarding the suitability of products for certain types of applications are based on VPG's knowledge of typical requirements that are often placed on VPG products. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. You should ensure you have the current version of the relevant information by contacting VPG prior to performing installation or use of the product, such as on our website at [vpgsensors.com](http://vpgsensors.com).

No license, express, implied, or otherwise, to any intellectual property rights is granted by this document, or by any conduct of VPG.

The products shown herein are not designed for use in life-saving or life-sustaining applications unless otherwise expressly indicated. Customers using or selling VPG products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify VPG for any damages arising or resulting from such use or sale. Please contact authorized VPG personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Copyright Vishay Precision Group, Inc., 2014. All rights reserved.